

## EMIF06-mSD02C3

## Mini and micro-SD card IPAD™ EMI filtering and ESD protection

#### **Features**

- EMI low-pass filter
- ESD protection ±15 kV (IEC 61000-4-2)
- Integrated pull up resistors to prevent bus floating when no card is connected
- 50 MHz clock frequency compatibility with C<sub>line</sub> < 20 pF
- Low power consumption
- Easy layout thanks to smart pin-out configuration
- Very low PCB space consuming
- High reliability offered by monolithic integration
- Reduction of parasitic elements thanks to CSP integration
- Lead-free package

#### Complies with the following standards:

- IEC 61000-4-2 level 4
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- MIL STD 883G Method 3015-7 Class 3A
- SD Specification Part 1, Physical Layer Specification, Version 2.0

## **Application**

Mini and micro (T-Flash) secure digital memory card in:

- Mobile phones
- Communication systems

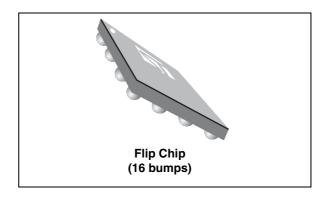
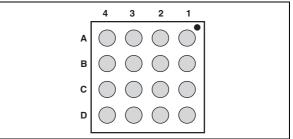


Figure 1. Pin configuration (bump side)



### **Description**

The EMIF06-mSD02C3 is a highly integrated device based on IPAD technology offering two functions: ESD protection to comply with IEC standard, and EMI filtering to reject mobile phone frequencies.

TM: IPAD is a trademark of STMicroelectronics

Characteristics EMIF06-mSD02C3

## 1 Characteristics

Table 1. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit
V <sub>PP</sub>	ESD discharge IEC 61000-4-2, air discharge ESD discharge IEC 61000-4-2, contact discharge	15 15	kV
V <sub>in</sub>	Maximum input voltage	5.5	٧
T <sub>j</sub>	Maximum junction temperature	125	°C
T <sub>op</sub>	Operating temperature range	- 40 to + 85	°C
T <sub>stg</sub>	Storage temperature range	- 55 to + 150	°C

Figure 2. EMIF06-mSD02C3 configuration

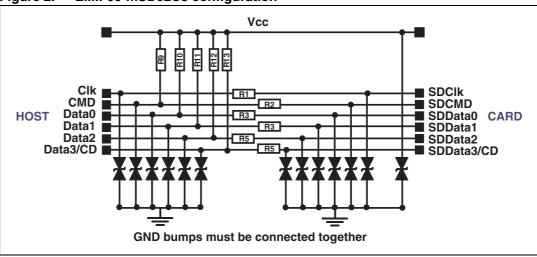


Table 2. Pin configuration

Pin	Signal	Pin	Signal
A1	DATA0	C1	CMD
A2	DATA1	C2	V <sub>ss</sub>
A3	SDDATA1	C3	$V_{ss}$
A4	SDDATA0	C4	SDCMD
B1	CLK	D1	DATA3/CD
B2	V <sub>cc</sub>	D2	DATA2
В3	$V_{ss}$	D3	SDDATA2
B4	SDCLK	D4	SDDATA3/CD

EMIF06-mSD02C3 Characteristics

Table 3. Electrical characteristic

Symbol	Test conditions	Min.	Тур.	Max.	Unit
V <sub>BR</sub>	I <sub>R</sub> = 1 mA	14	16		V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V			0.1	μΑ
R1, R2, R3, R4, R5, R6	Tolerance ± 20 %		40		Ω
R10, R11, R12, R13	Tolerance ± 30 %		56		kΩ
R9	Tolerance ± 30 %		4.7		kΩ
C <sub>line</sub>	V = 0 V, F = 1 MHz, V <sub>OSC</sub> = 30 mV		15	20	pF

Figure 3. S21 attenuation measurements Figure 4. Analog crosstalk measurements

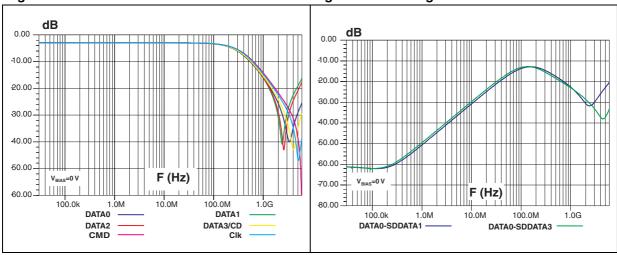
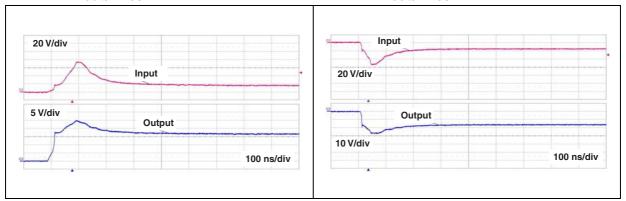


Figure 5. ESD response to IEC 61000-4-2 (+15 kV air discharge) on CLK and data lines

Figure 6. ESD response to IEC 61000-4-2 (-15 kV air discharge) on CLK and data lines



EMIF06-mSD02C3 **Characteristics** 

ESD response to IEC 61000-4-2 Figure 7. Figure 8. (+15 kV air discharge) on  $V_{CC}$  line

ESD response to IEC 61000-4-2 (-15 kV air discharge) on  $V_{CC}$  line

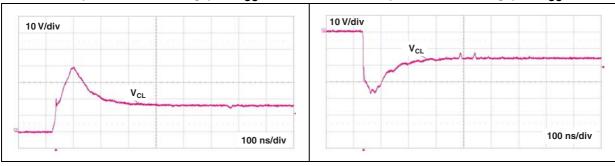
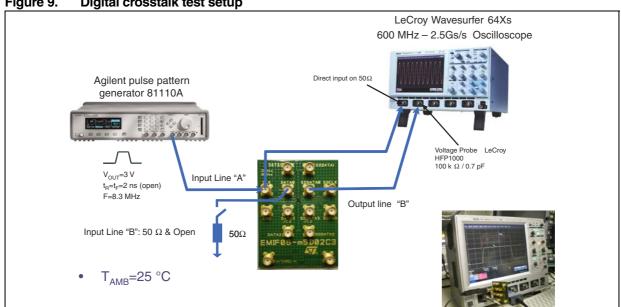
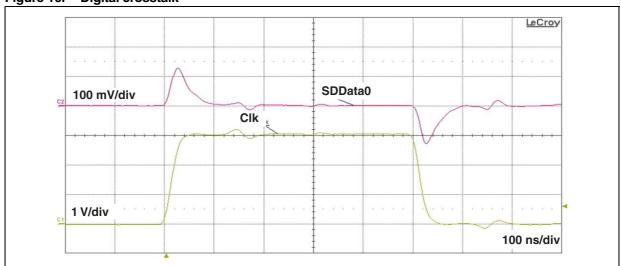


Figure 9. Digital crosstalk test setup







EMIF06-mSD02C3 Characteristics

Figure 11. Step response test setup

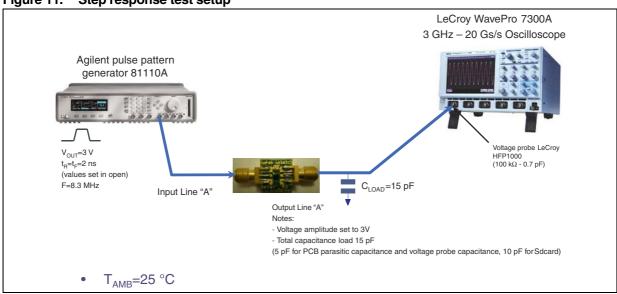


Figure 12. Step response without the filter

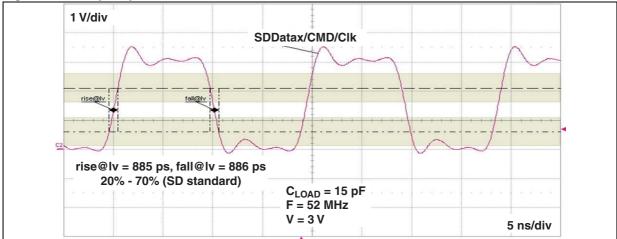
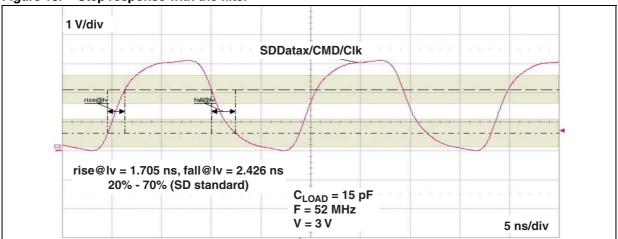


Figure 13. Step response with the filter



Characteristics EMIF06-mSD02C3

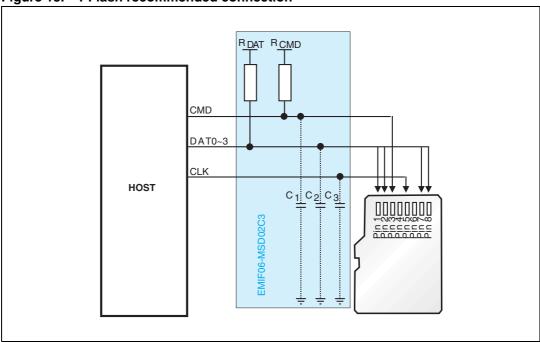
C(pF) 20.0 F = 10 Mhz  $V_{osc} = 30 \text{ m V}_{RMS}$   $T_j = 25 \text{ °C}$ 18.0 16.0 14.0 12.0 10.0 C1\_CMD A1\_Data0 A2\_Data1 D2\_Data2 D1\_Data3 B1\_Clk 8.0 6.0 4.0 2.0 0.0  $V_R(V)$ 1 2 3 4

Figure 14. Junction capacitance versus reverse applied voltage (typical values)

EMIF06-mSD02C3 Technical information

## 2 Technical information

Figure 15. T-Flash recommended connection



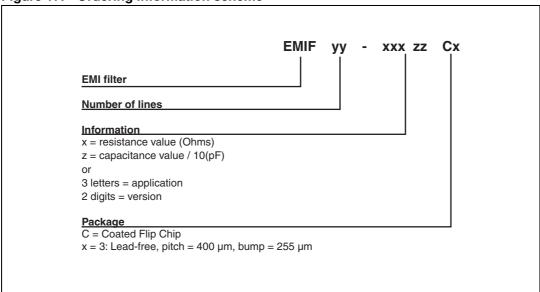
Pull-up resistances  $R_{DAT}$  and  $R_{CMD}$  are included to prevent bus floating when no card is inserted or when all card drivers are in high impedance mode.

The pull-up resistors and capacitors described in the above recommendation are integrated in the EMIF06-mSD02C3. This makes the EMIF06-mSD02C3 an easy "plug and play" solution to implement secured T-Flash, mini-SD and micro-SD card terminations.

Figure 16. Recommendation layout DATO VSS CLK CLK CMD DAT3/CD VCC DAT2 CMD Input GND DAT3/CD Top level DAT2 Second leel Top view: GND bumps must be connected together

## 3 Ordering information scheme

Figure 17. Ordering information scheme



## 4 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Figure 18. Package dimensions

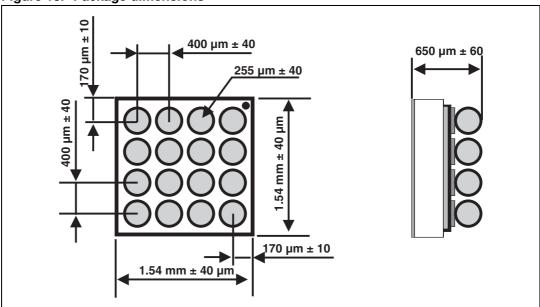
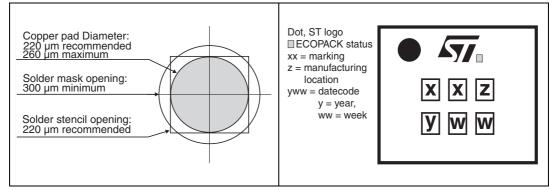


Figure 19. Footprint

Figure 20. Marking



Ordering information EMIF06-mSD02C3

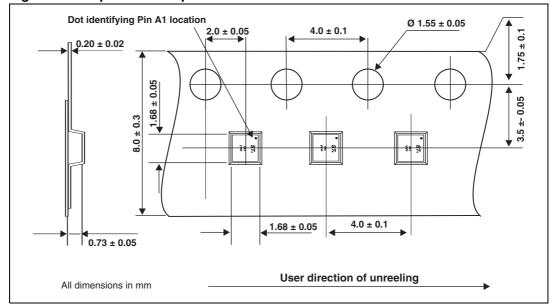


Figure 21. Tape and reel specification

## 5 Ordering information

Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF06-MSD02C3	JP	Flip Chip	3.2 mg	5000	Tape and reel 7"

Note: More inform

More information is available in the application notes:

AN2348: "Flip Chip: Package description and recommendations for use"

AN1751: "EMI Filters: Recommendations and measurements"

## 6 Revision history

Table 5. Document revision history

Date	Revision	Changes
12-Aug-2010	1	First issue.

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